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№ [1719]

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Abstract

The paper studies Thin Films based on Silica which doped with zinc ions (SiO₂:ZnO) at A Molar Ratio of (1:0.20; 1:0.30; 1:0.40) Deposited on Quartz and Silicon Substrates. The films were obtained by ion sputtering in a gaseous medium (argon/oxygen) from High-Silica targets obtained by the Sol-Gel method. The morphology and structure of the films were studied using scanning electron microscopy and X-ray phase analysis. X-ray phase analysis of the films revealed that the structure of the films is polycrystalline and has a hexagonal structure. The obtained frequency dependences of the dielectric permittivity of SiO₂:ZnO films showed a decrease in the dielectric permittivity and dielectric loss tangent in the range of (103 to 106) Hz. It has been found that when the SiO₂:ZnO film thickness is less than 100 nm, a thin-film capacitor is not always formed. The band gap of $E_g(ZnO)$ changes with increasing concentration from 3.564 to 2.598 eV, and $E_g(ZnO)$ changes with increasing concentration from 5.299 to 3.586 eV. A dip corresponding to the plasmon effect is observed in the transmission spectra in the region of 600–650 nm.

Keywords: Ion- beam Sputtering, Sol-gel, Zinc ion, Band gap, SiO₂:ZnO, Morphology, High-silica thin films, XRD, SEM.